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WELCOME TO XSIS ELECTRONICS Manufacturer of Hybrid Microcircuit Crystal Oscillators For Military, Space, and High Reliability Industrial and Telecommunications Applications

Over 33 Years of Delivering Outstanding Quality Hybrid Microcircuit Crystal Oscillators



NEW PRODUCTS

Type Number	Supply Voltage	Output Type	Output Enable	Frequency Range	Package Outline
XC5A	5.0 VDC	HCMOS/TTL	Yes	1.0 MHz - 105.0 MHz	
XC5L	3.3 VDC	HCMOS/TTL	Yes	1.0 MHz - 200.0 MHz	5x7 mm
XC5N	2.5 VDC	HCMOS	Yes	1.0 MHz - 190.0 MHz	Lead Less
XC5R	1.8 VDC	HCMOS	Yes	1.0 MHz - 160.0 MHz	
XE40-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	7x9 mm
XE40-200A	5 VDC	HC/ACMOS	Yes	400 K Hz to 90 MHz	ALTER DIR.
XE40-L00A	3.3 VDC	HC/ACMOS/TTL	Yes	400 KHz to 100 MHz	"J" Leads
XE30-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	9x14 mm
XE30-200A	5 VDC	HC/ACMOS	Yes	400 K Hz to 90 MHz	A TOS
XE30-L00A	3.3 VDC	HC/ACMOS/TTL	Yes	400 KHz to 100 MHz	"J" Leads
M55310/09	5.0 VDC	TTL	No	400.0 KHz - 60.0 MHz	8 Pin (Round)
M55310/27	5.0 VDC	HCMOS	Yes	1.0 MHz - 85.0 MHz	9x14 mm
M55310/30	3.3 VDC	HCMOS	Yes	450.0 KHz - 85.0 MHz	"J" Leads

PRODUCT HIGHLIGHTS

- QPL TO MIL-PRF-55310
 - 883B SCREENING
- CUSTOM HI-REL SCREENING
- TTL CMOS AC/HCMOS GATED ECL
 - COMPLEMENTARY OUTPUTS
 - MULTIPLE FREQUENCY OUTPUTS
 - WIDE FREQUENCY RANGES
- VARIETY OF FREQUENCY STABILITIES
 - MULTIPLE TEMPERATURE RANGES
 - DUAL IN-LINE PACKAGE
 - TO (Round) PACKAGE
- LEADLESS CHIP CARRIER (Surface Mount)
 - "J" LEAD PACKAGE (Surface Mount)
- "GULL WING" LEADS PACKAGE (Surface Mount)
- RESISTANCE WELDED, HERMETICALLY SEALED
 - HIGH SHOCK & VIBRATION DESIGNS

STANDARD PRODUCTS

Type No.	Supply Voltage	Output Type	Output Enable	Frequency Range	Package Outline
XC5A	5.0 VDC	HCMOS/TTL	YES	1.0 MHz - 105.0 MHz	
XC5L	3.3 VDC	HCMOS/TTL	YES	1.0 MHz - 200.0 MHz	5 x 7 mm
XC5N	2.5 VDC	HCMOS	YES	1.0 MHz - 190.0 MHz	Lead Less
XC5R	1.8 VDC	HCMOS	YES	1.0 MHz - 160.0 MHz	
XE40-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	9 x 7 mm
XE40-200A	5 VDC	HC/ACMOS	Yes	400 KHz to 90 MHz	
XE40-L00A	3.3 VDC	HC/ACMOS/TTL	Yes	400 KHz to 100 MHz	"J" Leads
XE30-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	9 x 14 mm
XE30-200A	5 VDC	HC/ACMOS	Yes	400 KHz to 90 MHz	
XE30-L00A	3.3 VDC	HC/ACMOS/TTL	Yes	400 KHz to 100 MHz	"J" Leads
X100	5 VDC	TTL	Yes	60 Hz to 90 MHz	
M100	5 VDC	TTL	No	60 Hz to 90 MHz	
E100	5 VDC	TTL	No	60 Hz to 90 MHz	14 Pin DIP
X200A	5 VDC	HC/ACMOS	Yes	5 Hz to 90 MHz	New York
X3200	3.3 VDC	HC/ACMOS/TTL	Yes	100 KHz to 100 MHz	
XL00	3.3 VDC	HC/ACMOS/TTL	Yes	100 KHz to 100 MHz	
X200	5 to 15 VDC	CMOS	No	1.5Hz to 12 MHz	14 Pin DIP
M200	5 to 15 VDC	CMOS	No	1.5Hz to 12 MHz	Tin and
E200	5 to 15 VDC	CMOS	No	1.5Hz to 12 MHz	
T100	5 VDC	TTL	Yes	60 Hz to 90 MHz	
T200	5 to 15 VDC	CMOS	No	1.5 Hz to12 MHz	4 Pin DIP
T200A	5 VDC	HC/ACMOS	Yes	5 Hz to 90 MHz	
T3200	3.3 VDC	HC/ACMOS/ TTL	Yes	100 KHz to 100 MHz	

XE20-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	TO (Round)
XE20-200A	5 VDC	HC/ACMOS	Yes	400 K Hz to 90 MHz	
XE20-L00A	3.3 VDC	HC/ACMOS/TTL	Yes	400 KHz to 100 MHz	
XE10-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	LCC
XE10-200A	5 VDC	HC/ACMOS	Yes	400 KHz to 90 MHz	
XE10-3200	3.3 VDC	HC/ACMOS	Yes	400 KHz to 100 MHz	Surface Mount
XE101-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	"J" Leads
XE101-200A	5 VDC	HC/ACMOS	Yes	400 KHz to 90 MHz	
XE101-3200	3.3 VDC	HC/ACMOS	Yes	400 KHz to 100 MHz	Surface Mount
XE102-100	5 VDC	TTL	Yes	400 KHz to 90 MHz	Gull Wing Leads
XE102-200A	5 VDC	HC/ACMOS	Yes	400 KHz to 90 MHz	a man an a
XE102-3200	3.3 VDC	HC/ACMOS	Yes	400 KHz to 100 MHz	Surface Mount
X300	-5.2 VDC	ECL	No	10.0 to 240 MHz	14 Pin DIP
X300A	-4.5 VDC	ECL	No	10.0 to 240 MHz	
Т300	-5.2 VDC	ECL	No	10.0 to 240 MHz	4 Pin DIP
T300A	-4.5 VDC	ECL	No	10.0 to 240 MHz	

QPL (M55310) OSCILLATORS

Type Number	Supply Voltage	Output Type	Output Enable	Frequency Range	Package Outline
M55310/08	5.0 VDC	TTL	No	100.0 Hz - 50.0 MHz	14 Pin DIP
M55310/09	5.0 VDC	TTL	No	400.0 KHz - 60.0 MHz	8 Pin Round
M55310/11	5 to 15 VDC	CMOS	No	50 KHz - 10.0 MHz	14 Pin DIP
M55310/14	5.0 VDC	TTL	No	100.0 Hz - 25.0 MHz	14 Pin DIP
M55310/15	5 to 15 VDC	CMOS	No	5.25 Hz - 10.0 MHz	14 Pin DIP
M55310/16	5.0 VDC	TTL	No	100.0 Hz - 80.0 MHz	14 Pin DIP
M55310/17	5.0 VDC	TTL (GATED)	Yes	250.0 KHz - 50.0 MHz	14 Pin DIP
M55310/18	5 to 15 VDC	CMOS	No	5.25 Hz - 15.0 MHz	14 Pin DIP
M55310/19	5.0 VDC	TTL	No	1.0 MHz - 60.0 MHz	.485"Sq. LCC
M55310/26	5.0 VDC	HCMOS	No	10.0 KHz - 65.0 MHz	14 Pin DIP
M55310/26	5.0 VDC	HCMOS	No	10.0 KHz - 65.0 MHz	4 Pin DIP
M55310/27 M55310/30	5.0 VDC 3.3 VDC	HCMOS HCMOS	Yes Yes	1.0 MHz - 85.0 MHz 450.0 KHz - 85.0 MHz	9x14mm "J" Leads

CRYSTAL OSCILLATORS FOR SPACE APPLICATIONS

Xsis Electronics is a leading supplier of Advance Design Rad-Hard Hybrid Crystal Oscillators for space applications. The following is a list of some of the space programs where Xsis oscillators have been used in flight hardware.

Program Name	Description
Spacebuss 3000B	Alcatel Telecommunication Satellite Program
Amos 3	Israel Telecommunication Satellite
Cryosat	ESA Earth Observation Satellite
нти	Japanese Space Vehicle to Space Station
TerraSar-X	German Earth Observation Satellite
Tandem-X	Second TerraSar-X
SMOS	ESA Earth Observation Satellite
Rapid Eye	ESA Earth Observation Satellite
Lisa Pathfinder	ESA/NASA Earth Observation Satellite
ISSR Mass Memory	Japanese Project
Express AM33, AM44	Russian Telecommunication Satellite

STANDARD ENVIRONMENTAL SPECIFICATIONS

Environmental Specifications are derived from MIL-PRF-55310 and are generally performed on a sampling basis for qualification to insure that all units in production meet or exceed the required specifications. This sampling method, coupled with Workmanship Standards to

MIL-PRF-38534, a Product Assurance Plan in accordance with MIL-STD-790 and a Quality System certified to ISO-9001, insures a superior product.

VIBRATION	0.06" DA, 30G Peak, 10 - 2000 Hz, MIL-STD-202, Method 204, Cond. G
SHOCK	1/2 Sine, 1500G Peak, MIL-STD-883, Method 2002, Cond. B
THERMAL SHOCK	MIL-STD-202, Method 107, Cond. B
ALTITUDE	MIL-STD-202, Method 105, Cond. C
MOISTURE RESISTANCE	MIL-STD-202, Method 106, Vibration Sub cycle Omitted
SALT SPRAY	MIL-STD-883, Method 1009, Cond. A
CONSTANT ACCELERATION	MIL-STD-883, Method 2001, 5000G
SOLDERABILITY	MIL-STD-202, Method 208
RESISTANCE TO SOLDERING HEAT	MIL-STD-202, Method 210, Cond. C or B as Applicable
RESISTANCE TO SOLVENTS	MIL-STD-202, Method 215
INTERNAL WATER VAPOR CONTENT	MIL-STD-883, Method 1018

883B SCREENING

(Same as MIL-PRF-55310, Class B Screening)

When 883B Screening is specified, Xsis oscillators are subjected to the following tests on a 100% basis. PDA for burn-in is in accordance with the requirements of MIL-PRF-55310 for Class B products.

Internal Visual	MIL-STD-883, Method 2017, Class B
Stabilization Bake	MIL-STD-883, Method 1008, Cond. C, 24 Hours Minimum
Temperature Cycling	MIL-STD-883, Method 1010, Cond. B
Constant Acceleration	MIL-STD-883, Method 2001, Cond. A, Y_1 only,(5000 G)
Seal (fine & gross leak)	MIL-STD-883, Method 1014
Electrical Tests	MIL-PRF-55310, Class B
Burn-in	+125 °C, Nominal Supply Voltage & Burn-in Load, 160 Hours Min.
Electrical Tests	MIL-PRF-55310, Class B

CUSTOM HI-REL SCREENING

(Similar to MIL-PRF-55310, "Class S" Screening)

When required by the customer, Xsis oscillators can be subjected to the following screening

tests on a 100% basis. PDA for burn-in & Non-Destruct Bond Pull are in accordance with the requirements of MIL-PRF-55310 for "class S" products.

Non-Destruct Bond Pull	MIL-STD-883, Method 2023 (PDA=2% or 1 wire whichever is greater)
Internal Visual	MIL-STD-883, Method 2017, Class "S", Except Class "B" for Elements
Stabilization Bake	MIL-STD-883, Method 1008, Cond. C, 48 Hours Minimum
Thermal Shock	MIL-STD-883, Method 1011, Cond. A
Temperature Cycling	MIL-STD-883, Method 1010, Cond. B
Constant Acceleration	MIL-STD-883, Method 2001, Cond. A, Y_1 only, ($5000\ G$)
Seal - fine & gross leak	MIL-STD-883, Method 1014
PIND	MIL-STD-883, Method 2020, Cond. A
Radiographic Insp.	MIL-STD-883, Method 2012
Electrical Tests	MIL-PRF-55310, Class B
Burn-in	+125 °C, Nominal Supply Voltage & Burn-in Load, 320 Hours Min.
Electrical Tests	MIL-PRF-55310, Class B

MICROCIRCUIT CRYSTAL OSCILLATOR

TERMINOLOGY

Nominal Frequency	Customer specified frequency
Frequency Accuracy @ +25 °C (Setting and/or Calibration Tolerance)	How close to the specified frequency the output frequency is factory adjusted at +25 °C.
Frequency Stability Vs. Temperature	The maximum frequency deviation over a specified temperature range with respect to the frequency measured at +25 °C \pm 1 °C. This can be expressed as a percentage, PPM, or in scientific notation, e.g. \pm 0.005%, or \pm 50PPM, or 50(10) ⁻⁶ .
Operating Temperature Range	The operating temperatures range over which the frequency stability and other electrical parameters must remain within their specified limits.
Aging	Long term frequency changes which are due primarily to variations in the crystal and other oscillator components.
Input Current	The current drawn by the device from the power source at a specified supply voltage.
Rise Time (TTL)	The time required for output voltage to rise from 0.6 VDC to 2.2 VDC.
Rise Time (CMOS & ECL)	The time required for output voltage to rise from 10% to 90% of the peak to peak output.
Fall Time (TTL)	The time required for output voltage to drop from 2.2 VDC to 0.6 VDC.
Fall Time (CMOS & ECL)	The time required for output voltage to drop from 90% to 10% of the peak to peak output amplitude.
Symmetry (TTL)	The percentage of time the output voltage is above the TTL threshold (1.4VDC $@$ +25 °C).
Symmetry (CMOS & ECL)	The percentage of time the output voltage is above the 50% of the peak to peak output amplitude

QUALITY MANAGEMENT SYSTEM

Xsis Electronics Quality Management System is designed to meet or exceed the requirements of ISO-9001, MIL-STD-790, and MIL-PRF-55310.

Xsis Electronics has been surveyed and approved by virtually every defense contractor in the United States, and worldwide. Xsis Electronics is currently certified for ISO-9001-2000, MIL-PRF-55310 and MIL-STD-790.